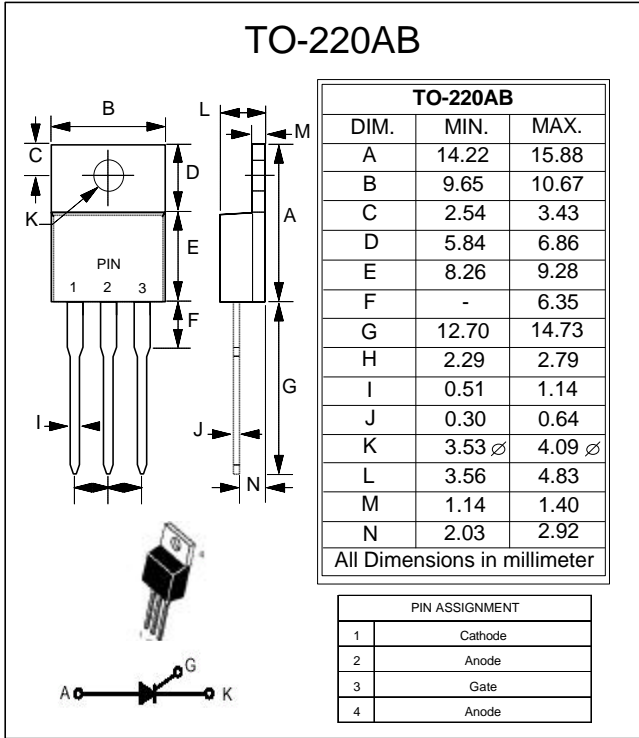


**Sensitive Gate
Silicon Controlled Rectifiers
Reverse Blocking Thyristors**

**SCRs
8 AMPERES RMS
400 thru 800 VOLTS**

- FEATURES**
- Blocking Voltage of 400 thru 800 Volts
 - On-State Current Rating of 8 Amperes RMS at 80
 - High Surge Current Capability - 80 Amperes
 - Rugged, Economical TO220AB Package
 - Glass Passivated Junctions for Reliability and Uniformity
 - Minimum and Maximum Values of IGT, VGT and IH Specified for Ease of Design
 - High Immunity to dv/dt - 100 V/msec Minimum at 110
 - Pb-Free Package



MAXIMUM RATINGS (T_J= 25 unless otherwise noticed)

| Rating | Symbol | Value | Unit |
|--|--|-------------------|------------------|
| Peak Repetitive Off- State Voltage (T _J = -40 to 125 , Sine Wave, 50 to 60 Hz; Gate Open) | V _{DRM} , V _{RRM} | 400 600 800 | Volts |
| On-State RMS Current (180° Conduction Angles, T _c = 80) | I _{T(RMS)} | 8 | Amp |
| Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, T _J = 25) | I _{TSM} | 80 | Amp |
| Circuit Fusing Consideration (t = 8.3 ms) | I ² t | 26.5 | A ² s |
| Forward Peak Gate Power (Pulse Width 1.0 us, T _c = 80) | P _{GM} | 5.0 | Watt |
| Forward Average Gate Power (t = 8.3 ms, T _c = 80) | P _{G(AV)} | 0.5 | Watt |
| Forward Peak Gate Current (Pulse Width 1.0 us, T _c = 80) | I _{GM} | 2.0 | Amp |
| Operating Junction Temperature Range | T _J | -40 to +125 | |
| Storage Temperature Range | T _{stg} | -40 to +150 | |

Notice: (1) V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded

REV. 3, Jun-2005, KTXC11

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|---|----------------|-------------|------|
| Thermal Resistance - Junction to Case - Junction to Ambient | RthJC RthJA | 2.2 62.5 | /W |
| Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds | TL | 260 | |

ELECTRICAL CHARACTERISTICS (T_J=25 unless otherwise noted)

| Characteristics | Symbol | Min | Typ | Max | Unit |
|-----------------|--------|-----|-----|-----|------|
|-----------------|--------|-----|-----|-----|------|

OFF CHARACTERISTICS

| | | | | | | |
|--|---|--------------------------------------|--------------|--------------|-----------|----------|
| Peak Repetitive Forward or Reverse Blocking Current (V _D =Rated V _{DRM} and V _{RRM} ; Gate Open) | T _J =25 T _J =125 | I _{DRM} I _{RRM} | ---- ---- | ---- ---- | 10 2.0 | uA mA |
|--|---|--------------------------------------|--------------|--------------|-----------|----------|

ON CHARACTERISTICS

| | | | | | | |
|---|---------------------|-----------------|------|------|-----|-------|
| Peak Forward On-State Voltage (I _T =16A Peak @T _p 2.0 ms, Duty Cycle 2%) | | V _{TM} | ---- | ---- | 1.8 | Volts |
| Gate Trigger Current (Continuous dc) (V _D = 12 V; R _L = 100 Ohms) | | I _{GT} | 2.0 | 7.0 | 15 | mA |
| Holding Current (V _D = 12 V, Gate Open, Initiating Current = 200 mA) | | I _H | 4.0 | 17 | 30 | mA |
| Latch Current (V _D = 12 V, I _G = 15 mA) | | I _L | 6.0 | 20 | 40 | mA |
| Gate Trigger Voltage (Continuous dc) (V _D = 12 V; R _L = 100 Ohms) | | V _{GT} | 0.5 | 0.65 | 1.0 | Volts |
| Gate Non - Trigger Voltage (V _D = 12V, R _L = 100 Ohms) | T _J =125 | V _{GD} | 0.2 | --- | --- | Volts |

DYNAMIC CHARACTERISTICS

| | | | | | |
|--|-------|------|------|------|------|
| Critical Rate of Rise of Off-State Voltage (V _D =Rated V _{DRM} , Exponential Waveform, Gate Open, T _J =125) | dv/dt | 100 | 250 | ---- | V/us |
| Repetitive Critical Rate of Rise of On-State Current I _{PK} =50A, P _w =40 usec, diG/dt=1A/usec, I _{gt} =50mA | di/dt | ---- | ---- | 50 | A/us |

*Indicates Pulse Test: Pulse Width 2.0 ms, Duty Cycle 2%.

| Symbol | Parameter |
|-----------|---|
| V_{DRM} | Peak Repetitive Off State Forward Voltage |
| I_{DRM} | Peak Forward Blocking Current |
| V_{RRM} | Peak Repetitive Off State Reverse Voltage |
| I_{RRM} | Peak Reverse Blocking Current |
| V_{TM} | Peak On State Voltage |
| I_H | Holding Current |

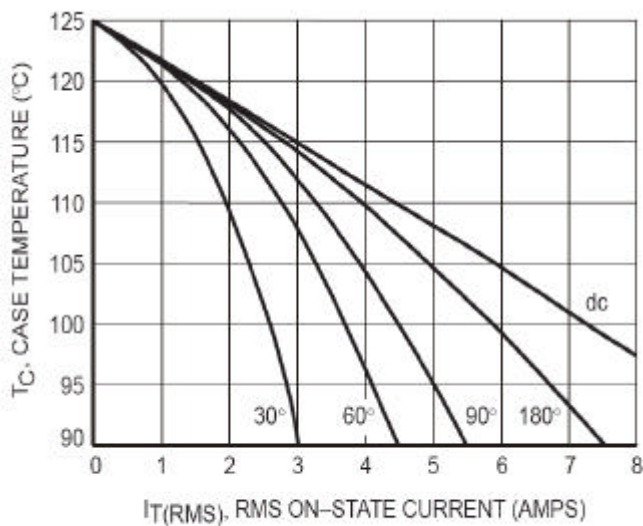
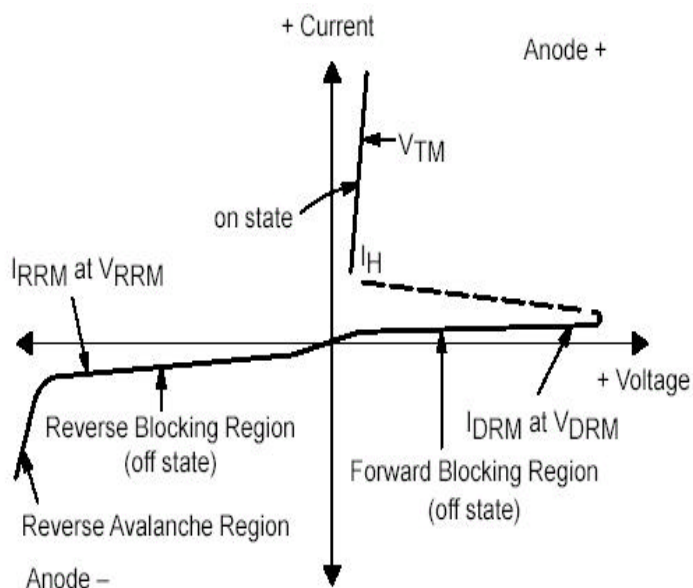


Figure 1. Typical RMS Current Derating

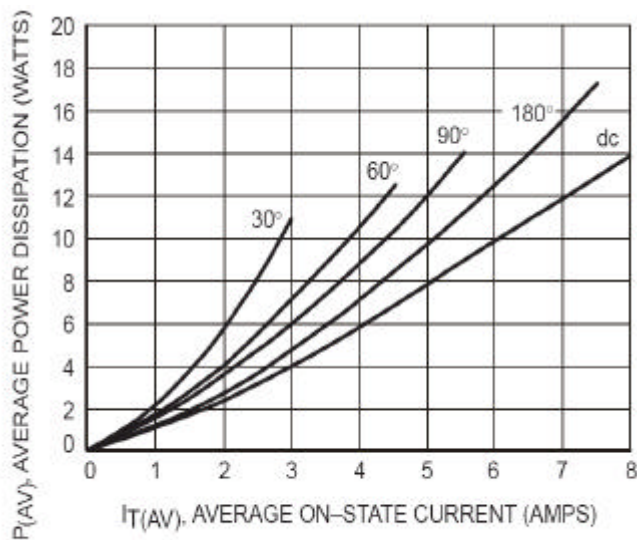


Figure 2. On-State Power Dissipation

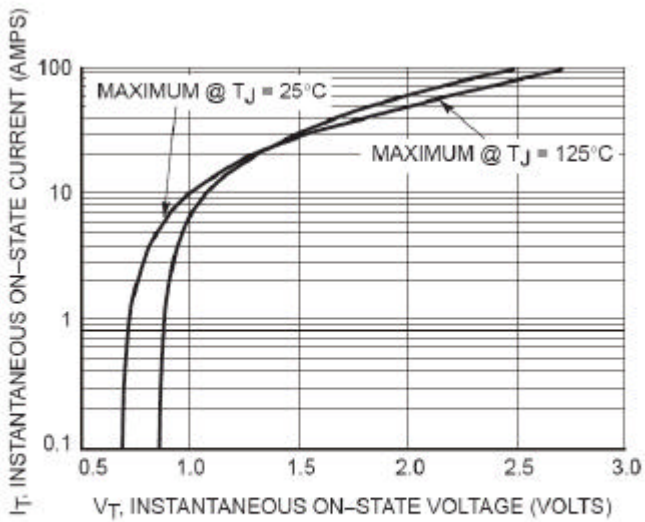


Figure 3. Typical On-State Characteristics

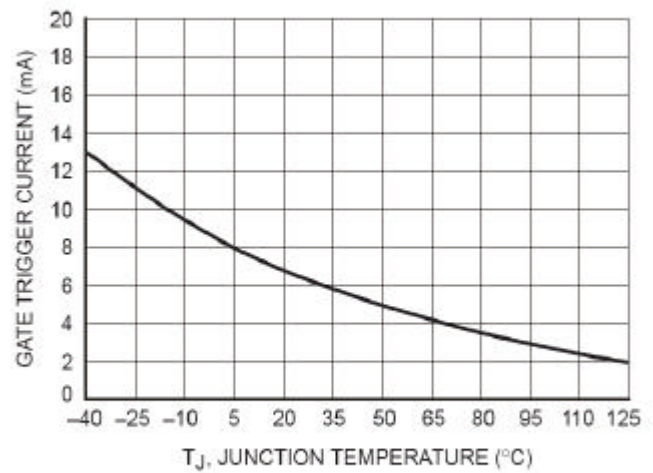


Figure 4. Typical Gate Trigger Current versus Junction Temperature

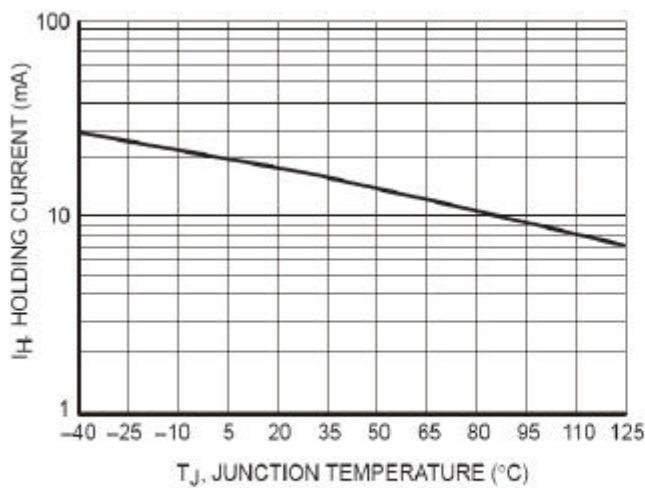


Figure 5. Typical Holding Current versus Junction Temperature

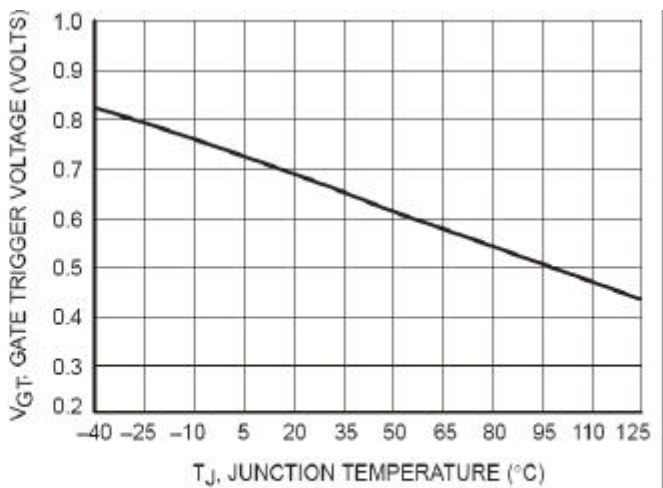


Figure 6. Typical Gate Trigger Voltage versus Junction Temperature

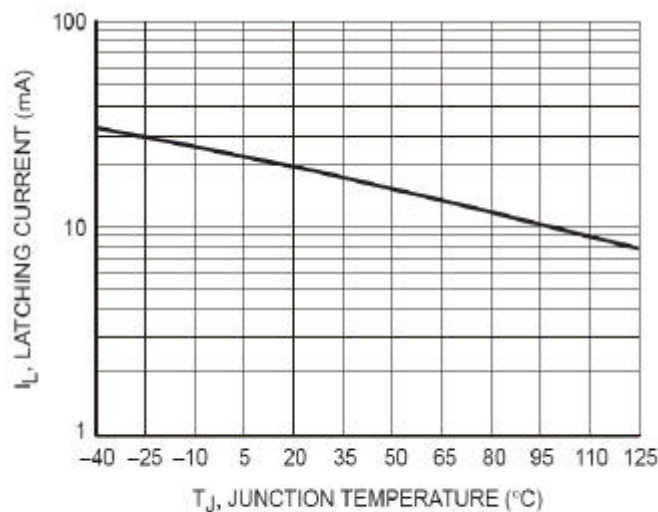


Figure 7. Typical Latching Current versus Junction Temperature